# PATENT ASSIGNMENT

Electronic Version v1.1 Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

## **CONVEYING PARTY DATA**

Name	Execution Date
Chingwen Chang	11/12/2007

## **RECEIVING PARTY DATA**

Name:	Taiwan Semiconductor Manufacturing Co., Ltd.
Street Address:	No.8, Li-Hsin Road 6, Science-Based Industrial Park
City:	Hsin-Chu
State/Country:	TAIWAN
Postal Code:	300-77

#### PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	11939982

## **CORRESPONDENCE DATA**

Fax Number: (415)882-8107

Correspondence will be sent via US Mail when the fax attempt is unsuccessful.

Phone: 415-882-8200

Email: carla.english@klgates.com

Correspondent Name: Howard Chen, Esq. K&L Gates, LLP

Address Line 1: 55 Second Street

Address Line 2: Suite 1700

Address Line 4: San Francisco, CALIFORNIA 94105

ATTORNEY DOCKET NUMBER: 1152604-00280

NAME OF SUBMITTER: Howard Chen, Esq.

Total Attachments: 2

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PATENT REEL: 020128 FRAME: 0597 Patent Attorney Docket No.: TSMC2007-0387

Attorney Reference No.: 52604-00280

## ASSIGNMENT AND AGREEMENT

For value received, I/we Chingwen Chang, hereby equally sell, assign and transfer to Taiwan Semiconductor Manufacturing Co., Ltd., with its principal place of business located at No. 8, Li-Hsin Road 6, Science-Based Industrial Park, Hsin-Chu, Taiwan 300-77, Republic of China, and their successors, assigns and legal representatives, the entire right, title and interest, for the United States of America, in and to certain inventions related to ELECTRICAL FUSE SELF TEST AND REPAIR for Letters Patent of described in U.S. Application Number 11/939,982 , 2007 and all the rights and privileges the United States filed on Nov. 14 in said application and under any and all Letters Patent and any divisions, continuations, continuations-in-part, reexamination certificates, reissues, and extensions thereof that may be granted in the United States for said inventions; and I/we also concurrently hereby sell, assign and transfer to Taiwan Semiconductor Manufacturing Co., Ltd. the entire right, title and interest in and to said inventions for all countries foreign to the United States, including all rights of priority arising from the application aforesaid, and all the rights and privileges under any and all forms of protection, including Letters Patent, that may be granted in said countries foreign to the United States for said inventions.

I/We authorize **Taiwan Semiconductor Manufacturing Co.**, Ltd. to make application for such protection in its own name and maintain such protection in any and all countries foreign to the United States, and to invoke and claim for any application for patent or other form of protection for said inventions, without further authorization from me/us, any and all benefits, including the right of priority provided by any and all treaties, conventions, or agreements.

I/We hereby consent that a copy of this assignment shall be deemed a full legal and formal equivalent of any document which may be required in any country in proof of the right of **Taiwan Semiconductor Manufacturing Co.**, **Ltd.** to apply for patent or other form of protection for said inventions and to claim the aforesaid benefit of the right of priority.

I/We request that any and all patents for said inventions be issued to **Taiwan** Semiconductor Manufacturing Co., Ltd. in the United States and in all countries foreign to the United States, or to such nominees as **Taiwan Semiconductor** Manufacturing Co., Ltd. may designate.

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PATENT REEL: 020128 FRAME: 0598 Patent Attorney Docket No.: T5MC2007-0387

Attorney Reference No.: 52604-00280

I/We agree that, when requested, I/we shall, without charge to Taiwan Semiconductor Manufacturing Co., Ltd. but at its expense, sign all papers, and do all acts which may be necessary, desirable or convenient in connection with said applications, patents, or other forms of protection.

Inventor No. 1:

Dated: 11/12/2007

Chingwen Chang

Mailing and Residence:
No. 7 Ln. 2 TAI-AN Street, TAIPEI, TAIWAN, R.O.C.

Citizenship: U.S, A.

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REEL: 020128 FRAME: 0599